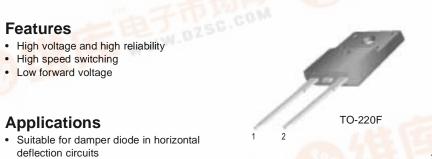


# **FFPF04U150S**

## **Applications**

 Suitable for damper diode in horizontal deflection circuits





1. Cathode 2. Anode

# DAMPER DIODE

## Absolute Maximum Ratings T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
$V_{RRM}$	Peak Repetitive Reverse Voltage	1500	V
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>C</sub> = 125°C	4	Α
I <sub>FSM</sub>	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	40	Α
T <sub>J,</sub> T <sub>STG</sub>	Operating Junction and StorageTemperature	- 65 to +150	°C

## **Thermal Characteristics**

Symbol	Symbol Parameter		Units	
Reac	Maximum Thermal Resistance, Junction to Case	4.0	°C/W	

## Electrical Characteristics T<sub>C</sub>=25 °C unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Units
V <sub>FM</sub> *	Maximum Instantaneous Forward Voltage	4.1	211		THE NAME OF	V
	$I_F = 4A$	$T_C = 25 ^{\circ}C$	1	- Y	1.8	
	I <sub>F</sub> = 4A	$T_C = 25 ^{\circ}C$ $T_C = 125 ^{\circ}C$	- 1	-	1.7	
I <sub>RM</sub> *	Maximum Instantaneous Reverse Current					μΑ
	@ rated V <sub>R</sub>	$T_C = 25  ^{\circ}C$	-	-	7	
	TO THE COM	$T_C = 25$ °C $T_C = 125$ °C	-	-	60	
t <sub>rr</sub>	Maximum Reverse Recovery Time (I <sub>F</sub> =1A, di/dt = 50A/μs)		-	-	150	ns
t <sub>fr</sub>	Maximum Forward Recovery Time (I <sub>F</sub> =6.5A, di/dt = 50A/μs)		-	-	400	ns
$V_{FRM}$	Maximum Forward Recovery Voltage		-	-	19	V

<sup>\*</sup> Pulse Test: Pulse Width=300µs, Duty Cycle=2%

# **Typical Characteristics**

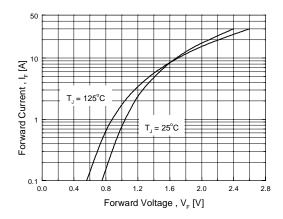


Figure 1. Typical Forward Voltage Drop vs. Forward Current

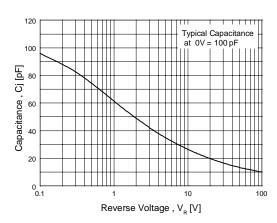


Figure 3. Typical Junction Capacitance

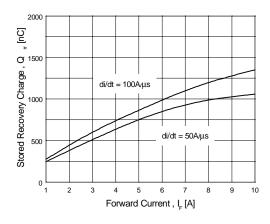


Figure 5. Typical Stored Charge vs. Forward Current

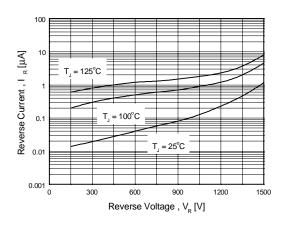


Figure 2. Typical Reverse Current vs. Reverse Voltage

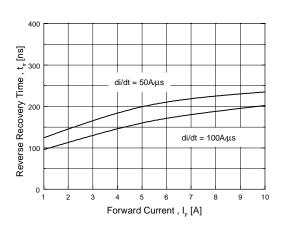


Figure 4. Typical Reverse Recovery Time vs. Forward Current

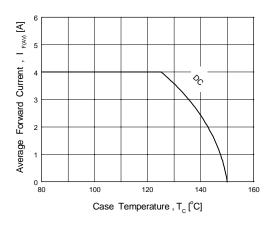
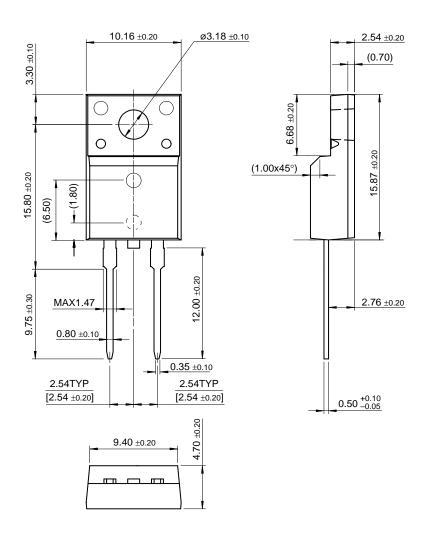


Figure 6. Forward Current Derating Curve

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# **Package Dimensions**

# TO-220F 2L



Dimensions in Millimeters

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HiSeC™ CROSSVOLT™ Quiet Series™ ISOPLANAR™ DOME™ SuperSOT™-3 E<sup>2</sup>CMOS<sup>TM</sup> MICROWIRE™ SuperSOT™-6 EnSigna™ OPTOLOGIC™ SuperSOT™-8 FACT™ OPTOPLANAR™ SyncFET™ POP™ FACT Quiet Series™ TinyLogic™

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## PRODUCT STATUS DEFINITIONS

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